



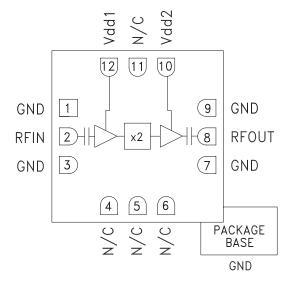
SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 24 - 33 GHz OUTPUT

Typical Applications

The HMC578LC3B is suitable for:

- Clock Generation Applications: SONET OC-192 & SDH STM-64
- Point-to-Point & VSAT Radios
- Test Instrumentation
- Military & Space

Functional Diagram



Features

High Output Power: +15 dBm Low Input Power Drive: 0 to +6 dBm Fo Isolation: >20 dBc @ Fout= 28 GHz 100 KHz SSB Phase Noise: -132 dBc/Hz Single Supply: +5V@ 81 mA RoHS Compliant 3x3 mm SMT Package

General Description

The HMC578LC3B is a x2 active broadband frequency multiplier utilizing GaAs PHEMT technology in a leadless RoHS compliant SMT package. When driven by a +3 dBm signal, the multiplier provides +15 dBm typical output power from 24 to 33 GHz. The Fo and 3Fo isolations are >20 dBc and >30 dBc respectively at 28 GHz. The HMC578LC3B is ideal for use in LO multiplier chains for Pt to Pt & VSAT Radios yielding reduced parts count vs. traditional approaches. The low additive SSB Phase Noise of -129 dBc/Hz at 100 kHz offset helps maintain good system noise performance. The RoHS packaged HMC578LC3B eliminates the need for wire bonding, and allows the use of surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vdd1, Vdd2 = +5V, 3 dBm Drive Level

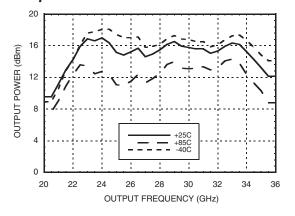
Parameter		Тур.	Max.	Units
Frequency Range, Input		12 - 16.5		GHz
Frequency Range, Output		24 - 33		GHz
Output Power	10	10 15		dBm
Fo Isolation (with respect to output level)		20		dBc
3Fo Isolation (with respect to output level)	on (with respect to output level) 30		dBc	
Input Return Loss		10		dB
Output Return Loss		12		dB
SSB Phase Noise (100 kHz Offset)		-132		dBc/Hz
Supply Current (Idd1 & Idd2)		81		mA



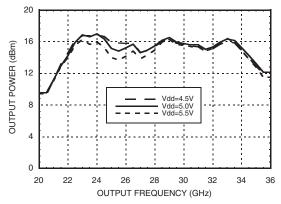


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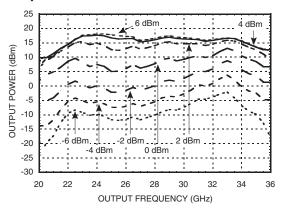
Output Power vs. Temperature @ 3 dBm Drive Level



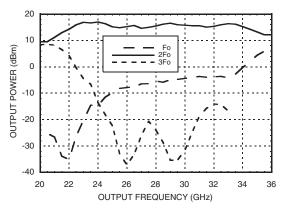
Output Power vs. Supply Voltage @ 3 dBm Drive Level

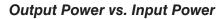


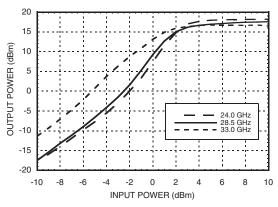
Output Power vs. Drive Level



Isolation @ 3 dBm Drive Level







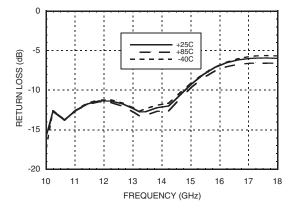
For price, delivery, and to place orders, please contact Hittite Microwave Corporation: 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com



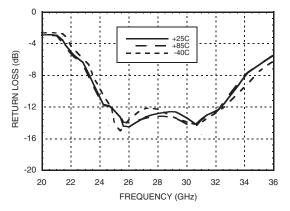


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Input Return Loss vs. Temperature



Output Return Loss vs. Temperature







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Absolute Maximum Ratings

RF Input (Vdd = +5V)	+13 dBm
Supply Voltage (Vdd)	+6.0 Vdc
Channel Temperature	175 °C
Continuous Pdiss (T= 85 °C) (derate 7.4 mW/°C above 85 °C)	670 mW
Thermal Resistance (channel to ground paddle)	135 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vdd

Vdd (Vdc)	ldd (mA)
4.5	81
5.0	81
5.5	81

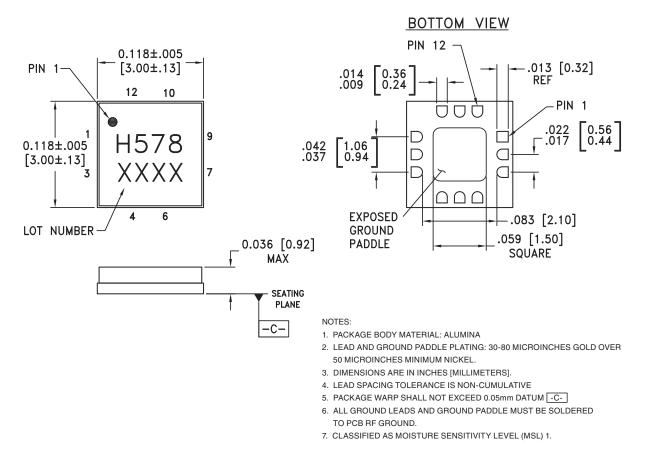
Note:

Multiplier will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing







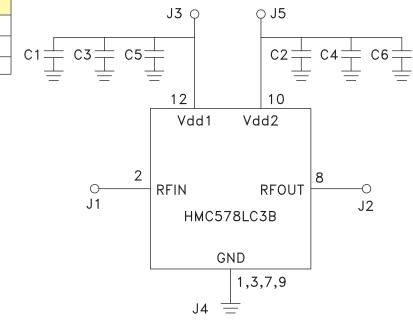
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Pin Description

Pin Number	Function	Description	Interface Schematic
1, 3, 7, 9	GND	Package bottom must also be connected to RF/DC ground.	GND =
2	RFIN	Pin is AC coupled and matched to 50 Ohms.	
4 - 6, 11	N/C	These pins are internally not connected; however, this product was specified with these pins connected to RF/ DC ground.	
8	RFOUT	Pin is AC coupled and matched to 50 Ohms.	
10, 12	Vdd2, Vdd1	Supply voltage 5V \pm 0.5V. External bypass capacitors of 100 pF, 1,000 pF and 2.2 μF are required.	Vdd1, Vdd2

Application Circuit

Compon	ent Value
C1, C2	2 100 pF
C3, C4	4 1,000 pF
C5, C6	6 2.2 μF



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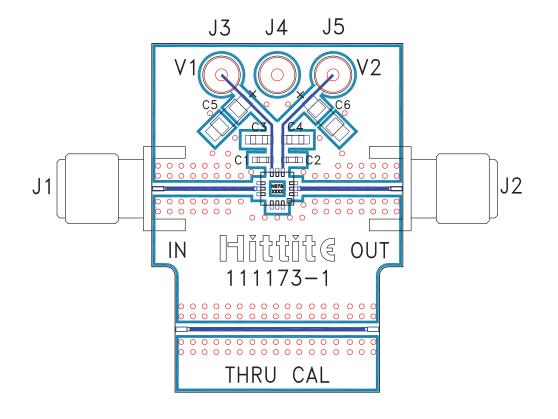




SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 24 - 33 GHz OUTPUT

ROHS

Evaluation PCB



List of Materials for Evaluation PCB 112409 [1]

Item	Description
J1, J2	PCB Mount SRI K Connector
J3 - J5	DC Pin
C1, C2	100 pF Capacitor, 0402 Pkg.
C3, C4	1,000 pF Capacitor, 0603 Pkg.
C5, C6	2.2 µF Tantalum Capacitor
U1	HMC578LC3B x2 Active Multiplier
PCB [2]	111173 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.